3.3 V, 155.52 MHz / 311.04 MHz LVPECL Clock Oscillator

The NBXDBB018 dual frequency crystal oscillator (XO) is designed to meet today's requirements for 3.3 V LVPECL clock generation applications. The device uses a high Q fundamental crystal and Phase Lock Loop (PLL) multiplier to provide selectable 155.52 MHz or 311.04 MHz, ultra low jitter and phase noise LVPECL differential output.

This device is a member of ON Semiconductor's PureEdge[™] clock family that provides accurate and precision clock solutions.

Available in 5 mm x 7 mm SMD (CLCC) package on 16 mm tape and reel in quantities of 1000. Frequency stability options available as either 50 PPM NBXDBA018 (Industrial Temperature Range) or 20 PPM NBXDBB018 (Commercial Temperature Range).

Features

- LVPECL Differential Output
- Uses High Q Fundamental Mode Crystal and PLL Multiplier
- Ultra Low Jitter and Phase Noise 0.4 ps (12 kHz 20 MHz)
- Selectable Output Frequency 155.52 MHz (default) / 311.04 MHz
- Hermetically Sealed Ceramic SMD Package
- RoHS Compliant
- Operating Range 3.3 V ±10%
- Total Frequency Stability ±20 PPM or ±50 PPM
- This is a Pb-Free Device

Applications

- Networking
- SONET
- SDH

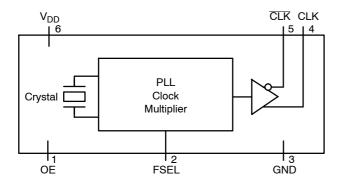


Figure 1. Simplified Logic Diagram



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6 PIN CLCC LN SUFFIX CASE 848AB

MARKING DIAGRAM

NBXDBA018 155.52/311.04 AAWLYYWWG NBXDBB018 155.52/311.04 AAWLYYWWG

 NBXDBA018
 = NBXDBA018 (±50 PPM)

 NBXDBB018
 = NBXDBB018 (±20 PPM)

 155.52/311.04
 = Output Frequency (MHz)

 AA
 = Assembly Location

WL = Wafer Lot
 YY = Year
 WW = Work Week
 G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
NBXDBB018LN1TAG	CLCC-6 (Pb-Free)	1000/ Tape & Reel
NBXDBA018LN1TAG	CLCC-6 (Pb-Free)	1000/ Tape & Reel
NBXDBB018LNHTAG	CLCC-6 (Pb-Free)	100/ Tape & Reel
NBXDBA018LNHTAG	CLCC-6 (Pb-Free)	100/ Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

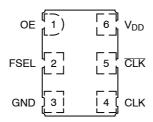


Figure 2. Pin Connections (Top View)

Table 1. PIN DESCRIPTION

Pin No.	Symbol	I/O	Description
1	OE	LVTTL/LVCMOS Control Input	Output Enable Pin. When left floating pin defaults to logic HIGH and output is active. See OE pin description Table 2.
2	FSEL	LVTTL/LVCMOS Control Input	Output Frequency Select Pin. Pin will default to logic HIGH when left open. See Output Frequency Select pin description Table 3.
3	GND	Power Supply	Ground 0 V
4	CLK	LVPECL Output	Non–Inverted Clock Output. Typically loaded with 50 Ω receiver termination resistor to V_{TT} = V_{DD} – 2 V .
5	CLK	LVPECL Output	Inverted Clock Output. Typically loaded with 50 Ω receiver termination resistor to V_{TT} = V_{DD} – 2 V.
6	V_{DD}	Power Supply	Positive power supply voltage. Voltage should not exceed 3.3 V ±10%.

Table 2. OUTPUT ENABLE TRI-STATE FUNCTION

OE Pin	Output Pins
Open	Active
HIGH Level	Active
LOW Level	High Z

Table 3. OUTPUT FREQUENCY SELECT

FSEL Pin	Output Frequency (MHz)
Open (pin will float high)	155.52
HIGH Level	155.52
LOW Level	311.04

Table 4. ATTRIBUTES

Characteristic		Value	
Input Default State Resistor		170 kΩ	
ESD Protection Human Body Model Machine Model			
Meets or Exceeds JEDEC Standard EIA/JESD78 IC Latchup Test			

^{1.} For additional Moisture Sensitivity information, refer to Application Note AND8003/D.

Table 5. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V_{DD}	Positive Power Supply	GND = 0 V		4.6	V
l _{out}	LVPECL Output Current	Continuous Surge		25 50	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-55 to +120	°C
T _{sol}	Wave Solder	See Figure 6		260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 6. DC CHARACTERISTICS (V_{DD} = 3.3 V \pm 10%, GND = 0 V, T_A = -40° C to $+85^{\circ}$ C) (Note 2)

Symbol	Characteristic	Conditions	Min.	Тур.	Max.	Units
I _{DD}	Power Supply Current (Note 2)			78	100	mA
V _{IH}	OE and FSEL Input HIGH Voltage		2000		V_{DD}	mV
V _{IL}	OE and FSEL Input LOW Voltage		GND - 300		800	mV
I _{IH}	Input HIGH Current OE FSEL		-100 -100		+100 +100	μΑ
I _{IL}	Input LOW Current OE FSEL		-100 -100		+100 +100	μΑ
V _{OH}	Output HIGH Voltage (Note 2)	V _{DD} = 3.3 V	V _{DD} -1195 2105		V _{DD} -945 2355	mV
V _{OL}	Output LOW Voltage (Note 2)	V _{DD} = 3.3 V	V _{DD} -1945 1355		V _{DD} -1600 1700	mV
V _{OUTPP}	Output Voltage Amplitude (Note 2)			670		mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

^{2.} Measurement taken with outputs terminated with 50 Ω to $\mbox{V}_{\mbox{DD}}$ – 2.0 V.

Table 7. AC CHARACTERISTICS (V_{DD} = $3.3~V \pm 10\%$, GND = 0~V, T_A = $-40^{\circ}C$ to $+85^{\circ}C$) (Note 3)

Symbol	Characteristic	Conditions	Min.	Тур.	Max.	Units
^f CLKOUT	Output Clock Frequency	FSEL = HIGH		155.52		MHz
		FSEL = LOW		311.04		1
Δf	Frequency Stability - NBXDBB018 - NBXDBA018	0°C to +70°C -40°C to +85°C (Note 4)			±20 ±50	ppm
Φ_{NOISE}	Phase-Noise Performance	100 Hz of Carrier		-105/-102		dBc/Hz
	f _{CLKout} = 155.52 MHz/311.04 MHz (See Figures 3 and 4)	1 kHz of Carrier		-122/-115		dBc/Hz
		10 kHz of Carrier		-129/-122		dBc/Hz
		100 kHz of Carrier		-129/-122		dBc/Hz
		1 MHz of Carrier		-137/-131		dBc/Hz
		10 MHz of Carrier		-160/-156		dBc/Hz
t _{jit} (Φ)	RMS Phase Jitter	12 kHz to 20 MHz		0.4	0.9	ps
t _{jitter}	Cycle to Cycle, RMS	1000 Cycles		2	8	ps
	Cycle to Cycle, Peak-to-Peak	1000 Cycles		13	30	ps
	Period, RMS	10000 Cycles		1	4	ps
	Period, Peak-to-Peak	10000 Cycles		9	20	ps
t _{OE/OD}	Output Enable/Disable Time				200	ns
tDUTY_CYCLE	Output Clock Duty Cycle (Measured at Cross Point)		48	50	52	%
t _R	Output Rise Time (20% and 80%)			250	400	ps
t _F	Output Fall Time (80% and 20%)			250	400	ps
t _{start}	Startup Time			1	5	ms
	Aging	1 st Year			3	ppm
		Every Year After 1st			1	ppm

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

^{3.} Measurement taken with outputs terminated with 50 Ω to V_{DD} – 2.0 V.

^{4.} Parameter guarantees 10 years of aging. Includes initial stability at 25°C, shock, vibration, and first year aging.

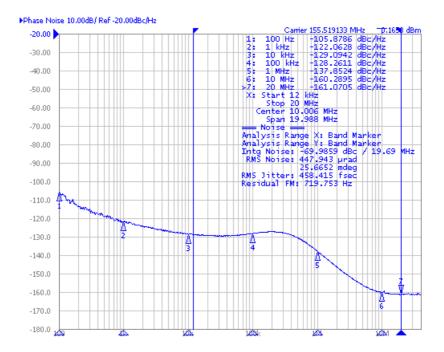


Figure 3. Typical Phase Noise Plot at 155.52 MHz

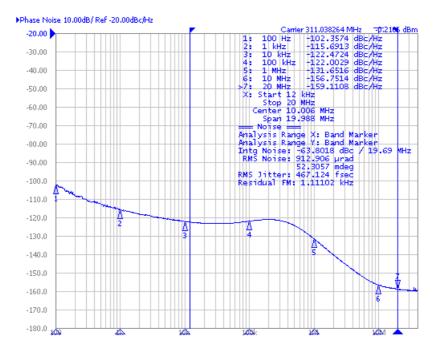


Figure 4. Typical Phase Noise Plot at 311.04 MHz

Table 8. RELIABILITY COMPLIANCE

Parameter	Standard	Method
Shock	Mechanical	MIL-STD-833, Method 2002, Condition B
Solderability	Mechanical	MIL-STD-833, Method 2003
Vibration	Mechanical	MIL-STD-833, Method 2007, Condition A
Solvent Resistance	Mechanical	MIL-STD-202, Method 215
Thermal Shock	Environment	MIL-STD-833, Method 1011, Condition A
Moisture Level Sensitivity	Environment	MSL1 260°C per IPC/JEDEC J-STD-020D

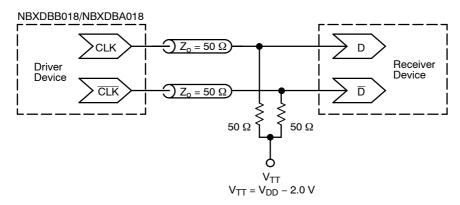


Figure 5. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

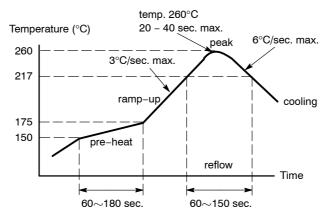
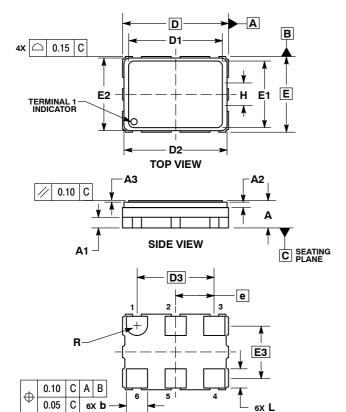


Figure 6. Recommended Reflow Soldering Profile

PACKAGE DIMENSIONS

6 PIN CLCC, 7x5, 2.54P CASE 848AB-01 ISSUE C



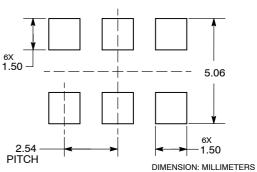
BOTTOM VIEW

NOTES:

- DIMENSIONING AND TOLERANCING PER
 ASME V14 5M 1994
- ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	1.70	1.80	1.90	
A1		0.70 REF		
A2		0.36 REF		
A3	0.08	0.10	0.12	
b	1.30	1.40	1.50	
D		7.00 BSC		
D1	6.17	6.20	6.23	
D2	6.66	6.81	6.96	
D3		5.08 BSC		
E		5.00 BSC		
E1	4.37	4.40	4.43	
E2	4.65	4.80	4.95	
E3	3.49 BSC			
е	2.54 BSC			
Н	1.80 REF			
L	1.17	1.27	1.37	
R	0.70 REF			

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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